# 3-647050-4 V ACTIVE

### MTA 100

TE Internal #: 3-647050-4

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.54 mm [.1

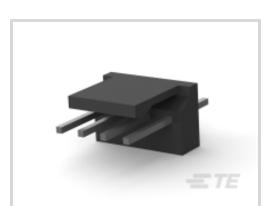
in] Centerline, Partially Shrouded, Tin, Through Hole - Solder,

Signal, MTA 100

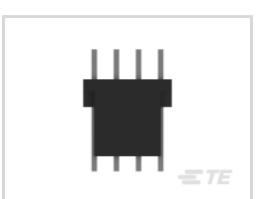
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Nylong Vertical PCB Header: 2.54mm, Through Hole, MTA 100











Connector System: Wire-to-Board

Number of Positions: 4
Number of Rows: 1

Centerline (Pitch): 2.54 mm [ .1 in ]
PCB Mount Orientation: Vertical

All Nylong Vertical PCB Header: 2.54mm, Through Hole, MTA 100 (25)

## **Features**

### **Product Type Features**

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Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC



Contact Features  Contact Mating Area Length 7.37 mm[.29 in]  Mating Square Post Dimension .64 mm[.025 in]  PCB Contact Termination Area Plating Material Thickness 3.81 – 6.3 µm[150 – 250 µin]  Contact Layout Inline  Contact Underplating Material Thickness 1.27 µm[50 µin]  Contact Mating Area Plating Material Thickness 3.81 – 6.3 µm[150 – 250 µin]  PCB Contact Termination Area Plating Material Finish Matte  Contact Shape & Form Square  Contact Mating Area Plating Material Finish Matte  Contact Underplating Material Nickel  PCB Contact Termination Area Plating Material Tin  Contact Base Material Contact Mating Area Plating Material Tin
Mating Square Post Dimension.64 mm[.025 in]PCB Contact Termination Area Plating Material Thickness3.81 – 6.3 μm[150 – 250 μin]Contact LayoutInlineContact Underplating Material Thickness1.27 μm[50 μin]Contact Mating Area Plating Material Thickness3.81 – 6.3 μm[150 – 250 μin]PCB Contact Termination Area Plating Material FinishMatteContact Shape & FormSquareContact Mating Area Plating Material FinishMatteContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTinContact Base MaterialCopper Alloy
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Contact Underplating Material  PCB Contact Termination Area Plating Material  Tin  Contact Base Material  Copper Alloy
PCB Contact Termination Area Plating Material  Contact Base Material  Copper Alloy
Contact Base Material Copper Alloy
Contact Mating Area Plating Material Tin
Contact Type Pin
Contact Current Rating (Max) 5 A
Termination Features
Square Termination Post & Tail Dimension .64 mm[.025 in]
Termination Post & Tail Length 3.43 mm[.135 in]
Termination Method to Printed Circuit Board Through Hole - Solder
Mechanical Attachment
Mating Alignment Type Polarization
Mating Retention With
Panel Mount Feature Without
Mating Retention Type Friction Lock
Connector Mounting Type Board Mount
Mating Alignment With
PCB Mount Alignment Without
PCB Mount Retention Without
Housing Features
Housing Material Nylon 4/6
Centerline (Pitch) 2.54 mm[.1 in]



### **Dimensions**

Connector Height	8.81 mm[.34 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA, UL
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500

Bag, Box

## **Product Compliance**

Packaging Type

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Pin-in-Paste capable to 260°C

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts











# Also in the Series | MTA 100



Insertion & Extraction Tools(2)



PCB Connector Covers(69)



PCB Connector Keying(1)



PCB Headers & Receptacles(440)



Standard Rectangular Connectors(495)



Wire-to-Board Connector Assemblies & Housings(1)



Wire-to-Board Connector Contacts(8)

# Customers Also Bought



















### **Documents**

### **Product Drawings**

04P MTA100 HDR ASSY F/L HITEMP

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_3-647050-4\_J\_c-3-647050-4-j.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_3-647050-4\_J\_c-3-647050-4-j.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_3-647050-4\_J\_c-3-647050-4-j.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English

**Product Environmental Compliance** 

MD\_3-647050-4\_0517201801\_dmtec

English

MD\_3-647050-4\_0517201801\_dmtec

English

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Agency Approvals

Agency Approval Document

English